



Packet No. IRV1.PAU.40

Patent Application

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

3729#
#7 / Amend
8M / A

In re Application of:

Examiner: Trinh, Minh N.

Albert, et al.

Group Art Unit: 3729

Serial No.: 09/770,864

Filed: January 26, 2001

For: STACKABLE MICROCIRCUIT
LAYER FORMED FROM A
PLASTIC ENCAPSULATED
MICROCIRCUIT AND METHOD OF
MAKING THE SAME

Irvine, California

RECEIVED
JAN 23 2003
TECHNOLOGY CENTER R3700

AMENDMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

Please enter the following amendment in response to the Office Action dated August 12, 2002. A request for a two-month extension of time and appropriate fees are enclosed. If necessary, please charge Deposit Account No. 01-1960.

IN THE TITLE

Please amend the title by replacing the title with the following: METHOD OF
MAKING A STACKABLE MICORCIRCUIT LAYER FROM A PLASTIC
ENCAPSULATED MICROCIRCUIT.

A1